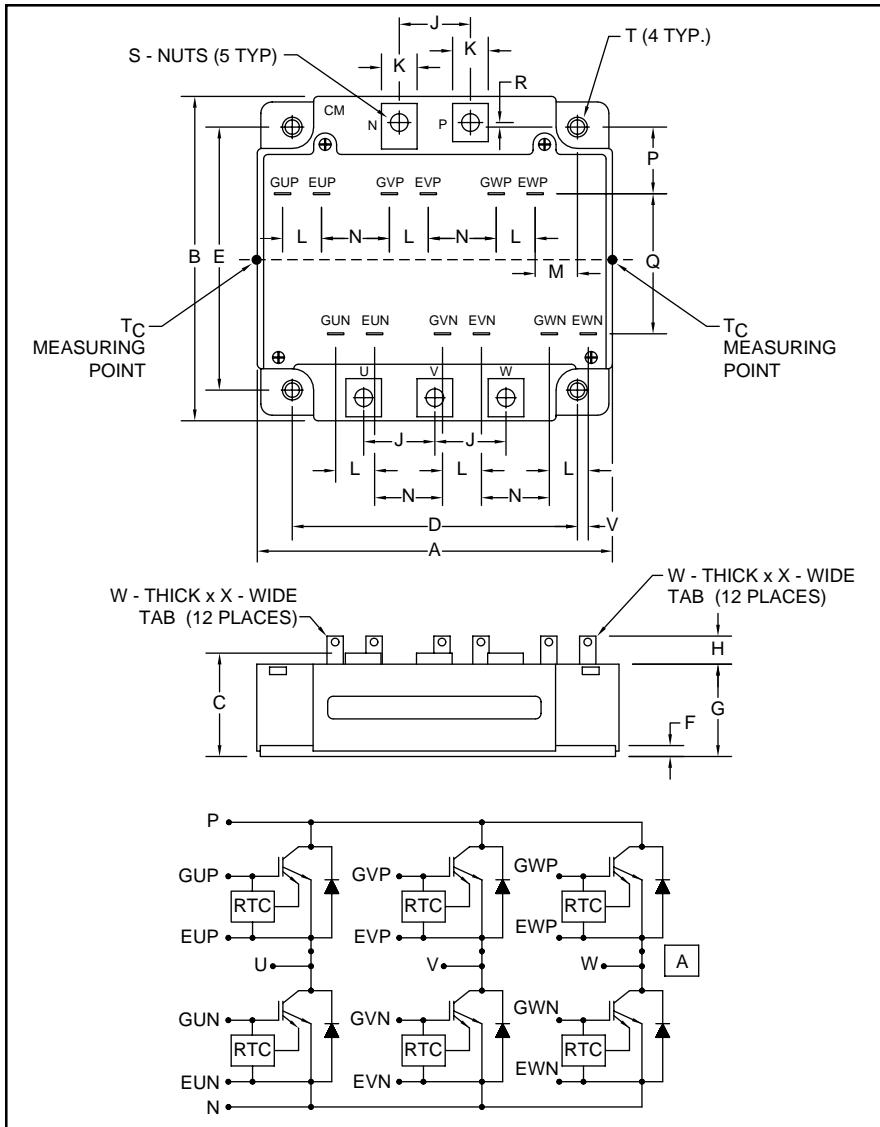


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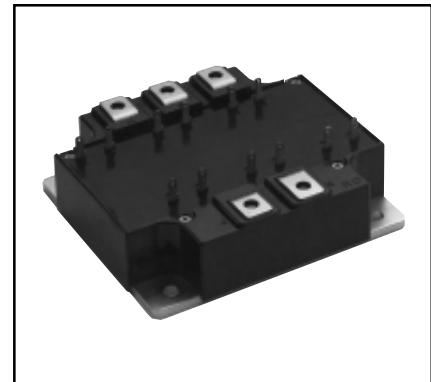
### Trench Gate Design Six IGBTMOD™ 200 Amperes/600 Volts



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
A	4.21	107.0
B	4.02	102.0
C	1.14 +0.04/-0.02	29.0 +1.0/-0.5
D	3.54±0.01	90.0±0.25
E	3.15±0.01	80.0±0.25
F	0.16	4.0
G	1.02	26.0
H	0.31	8.1
J	0.91	23.0
K	0.47	12.0
L	0.43	11.0

Dimensions	Inches	Millimeters
M	0.57	14.4
N	0.85	21.7
P	0.67	17.0
Q	1.91	48.5
R	0.15	3.75
S	M5	M5
T	0.22	5.5
V	0.03	0.8
W	0.02	0.5
X	0.110	2.79



#### Description:

Powerex IGBTMOD™ Modules are designed for use in switching applications. Each module consists of six IGBT Transistors in a three phase bridge configuration, with each transistor having a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

#### Features:

- Low Drive Power
- Low  $V_{CE(sat)}$
- Discrete Super-Fast Recovery Free-Wheel Diode
- Isolated Baseplate for Easy Heat Sinking

#### Applications:

- AC Motor Control
- UPS
- Battery Powered Supplies

#### Ordering Information:

Example: Select the complete module number you desire from the table - i.e. CM200TU-12F is a 600V ( $V_{CES}$ ), 200 Ampere Six-IGBT IGBTMOD™ Power Module.

Type	Current Rating Amperes	$V_{CES}$ Volts (x 50)
CM	200	12



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**CM200TU-12F**

Trench Gate Design Six IGBTMOD™  
200 Amperes/600 Volts

**Absolute Maximum Ratings,  $T_j = 25^\circ\text{C}$  unless otherwise specified**

Ratings	Symbol	CM200TU-12F	Units
Junction Temperature	$T_j$	-40 to 150	°C
Storage Temperature	$T_{stg}$	-40 to 125	°C
Collector-Emitter Voltage (G-E SHORT)	$V_{CES}$	600	Volts
Gate-Emitter Voltage (C-E SHORT)	$V_{GES}$	$\pm 20$	Volts
Collector Current ( $T_c = 25^\circ\text{C}$ )	$I_C$	200	Amperes
Peak Collector Current ( $T_j \leq 150^\circ\text{C}$ )	$I_{CM}$	400*	Amperes
Emitter Current**	$I_E$	200	Amperes
Peak Emitter Current**	$I_{EM}$	400*	Amperes
Maximum Collector Dissipation ( $T_j < 150^\circ\text{C}$ )	$P_c$	590	Watts
Mounting Torque, M5 Main Terminal	—	31	in-lb
Mounting Torque, M5 Mounting	—	31	in-lb
Weight	—	680	Grams
Isolation Voltage (Main Terminal to Baseplate, AC 1 min.)	$V_{iso}$	2500	Volts

**Static Electrical Characteristics,  $T_j = 25^\circ\text{C}$  unless otherwise specified**

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Collector-Cutoff Current	$I_{CES}$	$V_{CE} = V_{CES}, V_{GE} = 0V$	—	—	1	mA
Gate Leakage Voltage	$I_{GES}$	$V_{GE} = V_{CES}, V_{CE} = 0V$	—	—	20	μA
Gate-Emitter Threshold Voltage	$V_{GE(th)}$	$I_C = 20\text{mA}, V_{CE} = 10V$	5	6	7	Volts
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C = 200\text{A}, V_{GE} = 15V, T_j = 25^\circ\text{C}$ $I_C = 200\text{A}, V_{GE} = 15V, T_j = 125^\circ\text{C}$	—	1.6	2.2	Volts
Total Gate Charge	$Q_G$	$V_{CC} = 300V, I_C = 200\text{A}, V_{GE} = 15V$	—	1240	—	nC
Emitter-Collector Voltage**	$V_{EC}$	$I_E = 200\text{A}, V_{GE} = 0V$	—	—	2.6	Volts

\* Pulse width and repetition rate should be such that the device junction temperature ( $T_j$ ) does not exceed  $T_{j(\max)}$  rating.

\*\* Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).



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**CM200TU-12F**

**Trench Gate Design Six IGBTMOD™**

200 Amperes/600 Volts

**Dynamic Electrical Characteristics,  $T_j = 25^\circ\text{C}$  unless otherwise specified**

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Input Capacitance	$C_{ies}$		—	—	54	nf
Output Capacitance	$C_{oes}$	$V_{CE} = 10\text{V}, V_{GE} = 0\text{V}$	—	—	3.6	nf
Reverse Transfer Capacitance	$C_{res}$		—	—	2	nf
Inductive Load	Turn-on Delay Time $t_{d(on)}$	$V_{CC} = 300\text{V}, I_C = 200\text{A},$ $V_{GE1} = V_{GE2} = 15\text{V},$ $R_G = 3.1\Omega,$ Inductive Load	—	—	120	ns
Switch Times	Rise Time $t_r$		—	—	100	ns
Fall Time $t_f$	Turn-off Delay Time $t_{d(off)}$		—	—	350	ns
Diode Reverse Recovery Time** $t_{rr}$		Switching Operation	—	—	150	ns
Diode Reverse Recovery Charge** $Q_{rr}$		$I_E = 200\text{A}$	—	3.8	—	$\mu\text{C}$

**Thermal and Mechanical Characteristics,  $T_j = 25^\circ\text{C}$  unless otherwise specified**

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance, Junction to Case	$R_{th(j-c)}Q$	Per IGBT 1/6 Module, $T_c$ Reference Point per Outline Drawing	—	0.21	—	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction to Case	$R_{th(j-c)}D$	Per FWDI 1/6 Module, $T_c$ Reference Point per Outline Drawing	—	—	0.35	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction to Case	$R_{th(j-c)}'Q$	Per IGBT 1/6 Module, $T_c$ Reference Point Under Chip	—	0.13	—	$^\circ\text{C}/\text{W}$
Contact Thermal Resistance	$R_{th(c-f)}$	Per Module, Thermal Grease Applied	—	0.015	—	$^\circ\text{C}/\text{W}$

\*\* Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDI).